

PCN Number:	20210114000.1		PCN Date:	Feb 24, 2021	
Title:	Qualification of new Mold Compound for Select Devices				
Customer Contact:	PCN Manager	Dept:	Quality Services		
Proposed 1st Ship Date:	May 24, 2021	Estimated Sample Availability:	Date provided at sample request		
Change Type:					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Material
<input checked="" type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Materials
				<input type="checkbox"/>	Wafer Fab Process
PCN Details					
Description of Change:					
Texas Instruments is pleased to announce the qualification of a new mold compound for the devices in the Product Affected section below as follows. Device will remain on current Assembly site.					
		Current		New	
	Mold Compound	013102024401		131010100248	
Reason for Change:					
Current mold compound material is no longer available					
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):					
None					
Anticipated impact on Material Declaration					
<input type="checkbox"/>	No Impact to the Material Declaration	<input checked="" type="checkbox"/>	Material Declarations or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained from the TI ECO website .		
Changes to product identification resulting from this PCN:					
None					
Product Affected:					
CD4051BE	LM293P	LM393APE4	SN74HC14N		
CD4052BE	LM324N	LM393P	SN74HC164N		
CD4066BE	LM324NE3	LM393PE3	SN74HC165N		
CD4541BE	LM339AN	NA555P	SN74HC165NE4		
CD4541BEE4	LM339ANE4	NE5532P	SN74HC595N		
LM239N	LM339N	NE5532PE4	ULN2003AIN		
LM239NE4	LM339NE3	NE555P	ULN2003AINE4		
LM258AP	LM358AP	SN74HC00N	ULN2003AN		
LM258P	LM358P	SN74HC02N	ULN2003AN-SQ		
LM2902N	LM358PE3	SN74HC04N	ULN2003BN		
LM2904P	LM393AP	SN74HC138N			

Qualification Report

Approve Date 25-Nov-2020

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: <u>LM239N</u>	Qual Device: <u>LM293P</u>	Qual Device: <u>LM358P</u>	Qual Device: <u>ULN2003AIN</u>
-	Preconditioning (PDIP)	260C – MSL1	1/308/0	1/308/0	2/616/0	2/616/0
AC	**Autoclave 121C	96 Hours	1/77/0	1/77/0	2/154/0	2/154/0
HAST	**Biased HAST, 130C/85%RH	96 Hours	1/77/0	1/77/0	2/154/0	2/154/0
HTSL	**High Temp. Storage Bake, 150C	1000 Hours	1/77/0	1/77/0	2/154/0	2/154/0
TC	**T/C -65C/150C, -65C/+150C	500 Cycles	1/77/0	1/77/0	2/154/0	2/154/0
LI	Lead Integrity	-	1/24/0	1/24/0	2/48/0	2480
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass	Pass	Pass
VM	Visual Quality Reliability Inspection	Post Autoclave	Pass	Pass	Pass	Pass
VM	Visual Quality Reliability Inspection	Post Biased HAST	Pass	Pass	Pass	-
VM	Visual Quality Reliability Inspection	Post Temp Cycle	Pass	Pass	Pass	Pass
VM	Visual Quality Reliability Inspection	Post biased HAST	-	-	-	Pass
XRAY	X-ray	(top side only)	Pass	Pass	Pass	Pass

- QBS: Qual By Similarity
- Qual Device LM239N is qualified at NC-P
- Qual Device LM358P is qualified at NC-P
- Qual Device ULN2003AIN is qualified at NC-P
- Qual Device LM293P is qualified at NC-P

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles
Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

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